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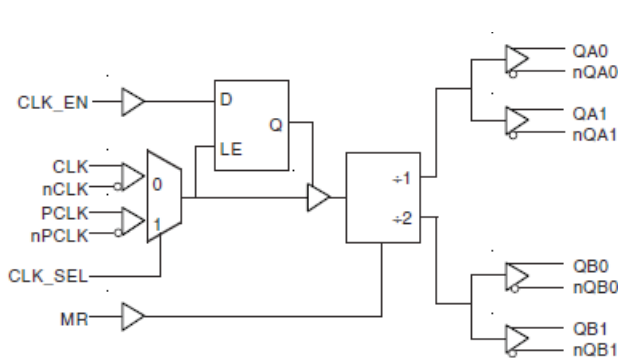# Contact us

GENERAL DESCRIPTION

The 8737I-11 is a low skew, high performance Differential-to-3.3V LVPECL ClockGenerator/Divider. The 8737I-11 has two selectable clock inputs. The CLK, nCLK pair can acceptmost standard differential input levels. The PCLK, nPCLK pair can accept LVPECL, CML, or SSTL input levels.The clock enable is internally synchronized to eliminate runt pulses on the outputs during asynchronous assertion/deassertion of the clock enable pin.

Guaranteed output and part-to-part skew characteristics make the 8737I-11 ideal for clock distribution applications demanding well defined performance and repeatability.

FEATURES

- Two divide by 1 differential 3.3V LVPECL outputs; Two divide by 2 differential 3.3V LVPECL outputs

- Selectable differential CLK, nCLK or LVPECL clock inputs

- CLK, nCLK pair can accept the following differential input levels: LVDS, LVPECL, LVHSTL, SSTL, HCSL

- PCLK, nPCLK supports the following input types: LVPECL, CML, SSTL

- Maximum output frequency: 650MHz

- Translates any single ended input signal (LVCMOS, LVTTL, GTL) to LVPECL levels with resistor bias on nCLK input

- Output skew: 75ps (maximum)

- Part-to-part skew: 300ps (maximum)

- Bank skew: Bank A - 30ps (maximum)
             Bank B - 45ps (maximum)

- 3.3V operating supply

- -40°C to 85°C ambient operating temperature

- Available in lead-free RoHS-compliant package

BLOCK DIAGRAM

PIN ASSIGNMENT

8737I-11
20-Lead TSSOP
6.50mm x 4.40mm x 0.92 package body
G Package
Top View

TABLE 1. PIN DESCRIPTIONS

Number	Name	Type		Description
1	V_{EE}	Power		Negative supply pin.
2	CLK_EN	Power	Pullup	Synchronizing clock enable. When HIGH, clock outputs follow clock input. When LOW, Q outputs are forced low, nQ outputs are forced high. LVCMOS / LVTTL interface levels.
3	CLK_SEL	Input	Pulldown	Clock Select input. When HIGH, selects PCLK, nPCLK inputs. When LOW, selects CLK, nCLK inputs. LVCMOS / LVTTL interface levels.
4	CLK	Input	Pulldown	Non-inverting differential clock input.
5	nCLK	Input	Pullup	Inverting differential clock input.
6	PCLK	Input	Pulldown	Non-inverting differential LVPECL clock input.
7	nPCLK	Input	Pullup	Inverting differential LVPECL clock input.
8	nc	Unused		No connect.
9	MR	Input	Pulldown	Active HIGH Master Reset. When logic HIGH, the internal dividers are reset. When LOW, the Master Reset is disabled. LVCMOS / LVTTL interface levels.
10, 13, 18	V_{CC}	Power		Positive supply pins.
11, 12	nQB1, QB1	Output		Differential output pair. LVPECL interface levels.
14, 15	nQB0, QB0	Output		Differential output pair. LVPECL interface levels.
16, 17	nQA1, QA1	Output		Differential output pair. LVPECL interface levels.
19, 20	nQA0, QA0	Output		Differential output pair. LVPECL interface levels.

NOTE: *Pullup* and *Pulldown* refer to internal input resistors. See Table 2, Pin Characteristics, for typical values.

### TABLE 2. PIN CHARACTERISTICS

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C_{IN}	Input Capacitance			4		pF
R_{PULLUP}	Input Pullup Resistor			51		kΩ
$R_{PULLDOWN}$	Input Pulldown Resistor			51		kΩ

TABLE 3A. CONTROL INPUT FUNCTION TABLE

Inputs				Outputs			
MR	CLK_EN	CLK_SEL	Selected Source	QA0, QA1	nQA0, nQA1	QB0, QB1	nQB0, nQB1
1	X	X	X	LOW	HIGH	LOW	HIGH
0	0	0	CLK, nCLK	Disabled; LOW	Disabled; HIGH	Disabled; LOW	Disabled; HIGH
0	0	1	PCLK, nPCLK	Disabled; LOW	Disabled; HIGH	Disabled; LOW	Disabled; HIGH
0	1	0	CLK, nCLK	Enabled	Enabled	Enabled	Enabled
0	1	1	PCLK, nPCLK	Enabled	Enabled	Enabled	Enabled

After CLK_EN switches, the clock outputs are disabled or enabled following a rising and falling input clock edge as shown in Figure 1.
In the active mode, the state of the outputs are a function of the CLK, nCLK and PCLK, nPCLK inputs as described in Table 3B.
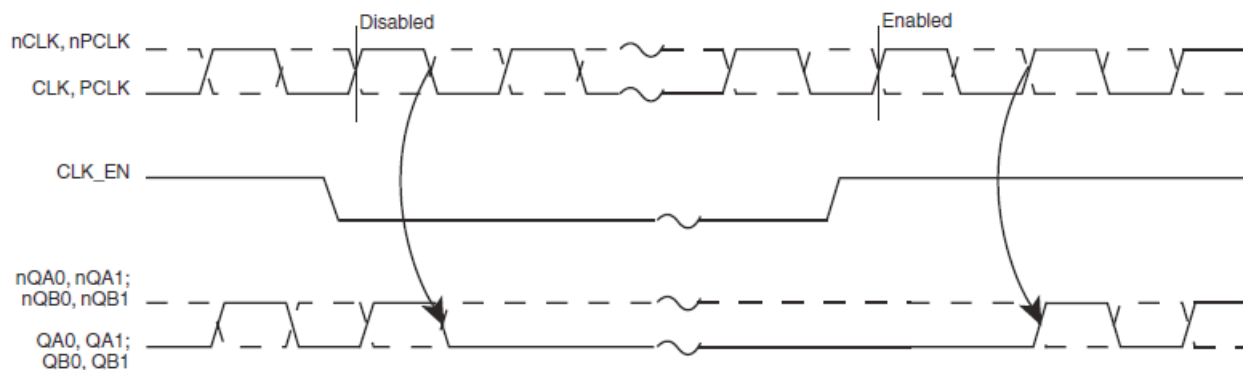
FIGURE 1 - CLK_EN TIMING DIAGRAM

TABLE 3B. CLOCK INPUT FUNCTION TABLE

Inputs		Outputs				Input to Output Mode	Polarity
CLK or PCLK	nCLK or nPCLK	QAx	nQAx	QBx	nQBx		
0	0	LOW	HIGH	LOW	HIGH	Differential to Differential	Non Inverting
1	1	HIGH	LOW	HIGH	LOW	Differential to Differential	Non Inverting
0	Biased; NOTE 1	LOW	HIGH	LOW	HIGH	Single Ended to Differential	Non Inverting
1	Biased; NOTE 1	HIGH	LOW	HIGH	LOW	Single Ended to Differential	Non Inverting
Biased; NOTE 1	0	HIGH	LOW	HIGH	LOW	Single Ended to Differential	Inverting
Biased; NOTE 1	1	LOW	HIGH	LOW	HIGH	Single Ended to Differential	Inverting

NOTE 1: Please refer to the Application Information section, "Wiring the Differential Input to Accept Single Ended Levels".

ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_{CC}	4.6V
Inputs, V_I	-0.5V to V_{CC} + 0.5V
Outputs, I_O	
Continuous Current	50mA
Surge Current	100mA
Package Thermal Impedance, θ_{JA}	73.2°C/W (0 lfpm)
Storage Temperature, T_{STG}	-65°C to 150°C

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

TABLE 4A. POWER SUPPLY DC CHARACTERISTICS, V_{CC} = 3.3V±5%, T_A = -40°C TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{CC}	Positive Supply Voltage		3.135	3.3	3.465	V
I_{EE}	Power Supply Current				55	mA

TABLE 4B. LVCMOS / LVTTL DC CHARACTERISTICS, V_{CC} = 3.3V±5%, T_A = -40°C TO 85°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V_{IH}	Input High Voltage			2		V_{CC} + 0.3	V
V_{IL}	Input Low Voltage			-0.3		0.8	V
I_{IH}	Input High Current	CLK_EN	V_{IN} = V_{CC} = 3.465V			5	µA
		CLK_SEL, MR	V_{IN} = V_{CC} = 3.465V			150	µA
I_{IL}	Input Low Current	CLK_EN	V_{IN} = 0V, V_{CC} = 3.465V	-150			µA
		CLK_SEL, MR	V_{IN} = 0V, V_{CC} = 3.465V	-5			µA

TABLE 4C. DIFFERENTIAL DC CHARACTERISTICS, V_{CC} = 3.3V±5%, T_A = -40°C TO 85°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
I_{IH}	Input High Current	nCLK	V_{IN} = V_{CC} = 3.465V			5	µA
		CLK	V_{IN} = V_{CC} = 3.465V			150	µA
I_{IL}	Input Low Current	nCLK	V_{IN} = 0V, V_{CC} = 3.465V	-150			µA
		CLK	V_{IN} = 0V, V_{CC} = 3.465V	-5			µA
V_{PP}	Peak-to-Peak Input Voltage			0.15		1.3	V
V_{CMR}	Common Mode Input Voltage; NOTE 1, 2			V_{EE} + 0.5		V_{CC} - 0.85	V

NOTE 1: For single ended applications, the maximum input voltage for CLK, nCLK is V_{CC} + 0.3V.
NOTE 2: Common mode voltage is defined as V_{IH}.

TABLE 4D. LVPECL DC CHARACTERISTICS, V_{CC} = 3.3V±5%, T_A = -40°C TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
I_{IH}	Input High Current	V_{IN} = V_{CC} = 3.465V			150	µA
		V_{IN} = V_{CC} = 3.465V			5	µA
I_{IL}	Input Low Current	V_{IN} = 0V, V_{CC} = 3.465V	-5			µA
		V_{IN} = 0V, V_{CC} = 3.465V	-150			µA
V_{PP}	Peak-to-Peak Input Voltage		0.3		1	V
V_{CMR}	Common Mode Input Voltage; NOTE 1, 2		V_{EE} + 1.5		V_{CC}	V
V_{OH}	Output High Voltage; NOTE 3		V_{CC} - 1.4		V_{CC} - 0.9	V
V_{OL}	Output Low Voltage; NOTE 3		V_{CC} - 2.0		V_{CC} - 1.7	V
V_{SWING}	Peak-to-Peak Output Voltage Swing		0.6		1.0	V

NOTE 1: Common mode voltage is defined as V_{IH}.
NOTE 2: For single ended applications, the maximum input voltage for PCLK, nPCLK is V_{CC} + 0.3V.
NOTE 3: Outputs terminated with 50Ω to V_{CC} - 2V.

TABLE 5. AC CHARACTERISTICS, V_{CC} = 3.3V±5%, T_A = -40°C TO 85°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
f_{MAX}	Output Frequency					650	MHz
t_{PD}	Propagation Delay; NOTE 1	CLK, nCLK	f ≤ 650MHz	1.2		1.8	ns
		PCLK, nPCLK	f ≤ 650MHz	1.1		1.7	ns
tsk(o)	Output Skew; NOTE 2, 4					75	ps
tsk(b)	Bank Skew; NOTE 4	Bank A				30	ps
		Bank B				45	ps
tsk(pp)	Part-to-Part Skew; NOTE 3, 4					300	ps
t_R	Output Rise Time		20% to 80% @ 50MHz	300		700	ps
t_F	Output Fall Time		20% to 80% @ 50MHz	300		700	ps
odc	Output Duty Cycle			47	50	53	%

All parameters measured at 500MHz unless noted otherwise.
The cycle-to-cycle jitter on the input will equal the jitter on the output. The part does not add jitter.
NOTE 1: Measured from the differential input crossing point to the differential output crossing point.
NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions.
Measured at the output differential cross points.
NOTE 3: Defined as skew between outputs on different devices operating at the same supply voltages
and with equal load conditions. Using the same type of inputs on each device, the outputs are measured
at the differential cross points.
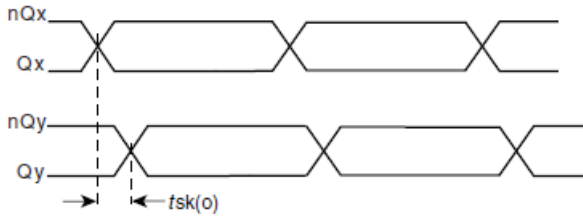NOTE 4: This parameter is defined in accordance with JEDEC Standard 65.

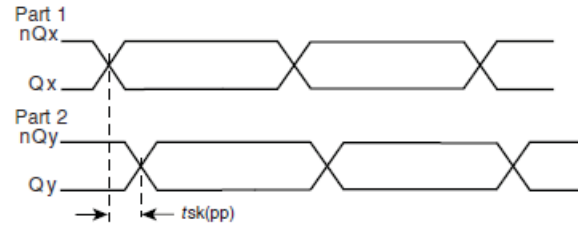# PARAMETER MEASUREMENT INFORMATION
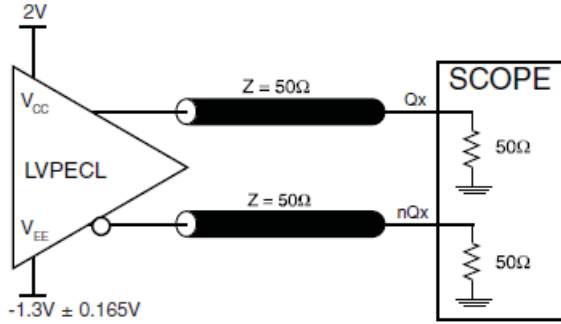
3.3V OUTPUT LOAD AC TEST CIRCUIT
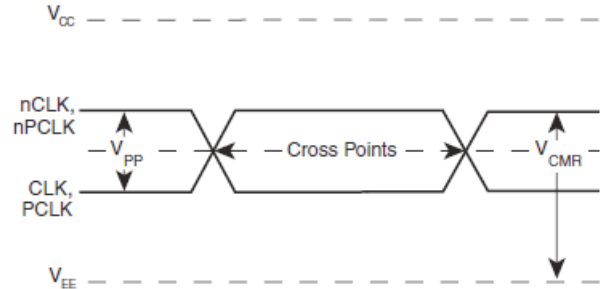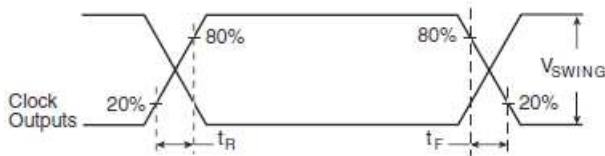

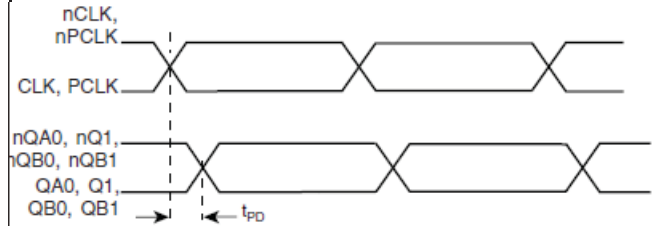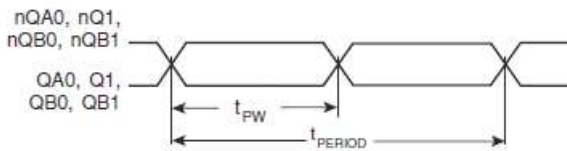**DIFFERENTIAL INPUT LEVEL**

OUTPUT SKEW

PART-TO-PART SKEW

OUTPUT RISE/FALL TIME

PROPAGATION DELAY

$$odc = \frac{t_{PW}}{t_{PERIOD}} \times 100\%$$

OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD

APPLICATION INFORMATION

WIRING THE DIFFERENTIAL INPUT TO ACCEPT SINGLE ENDED LEVELS

Figure 2 shows how the differential input can be wired to accept single ended levels. The reference voltage V_REF $\sim$ V$_{CC}$/2 is generated by the bias resistors R1, R2 and C1. This bias circuit should be located as close as possible to the input pin. The ratio of R1 and R2 might need to be adjusted to position the V_REF in the center of the input voltage swing. For example, if the input clock swing is only 2.5V and V$_{CC}$ = 3.3V, V_REF should be 1.25V and R2/R1 = 0.609.
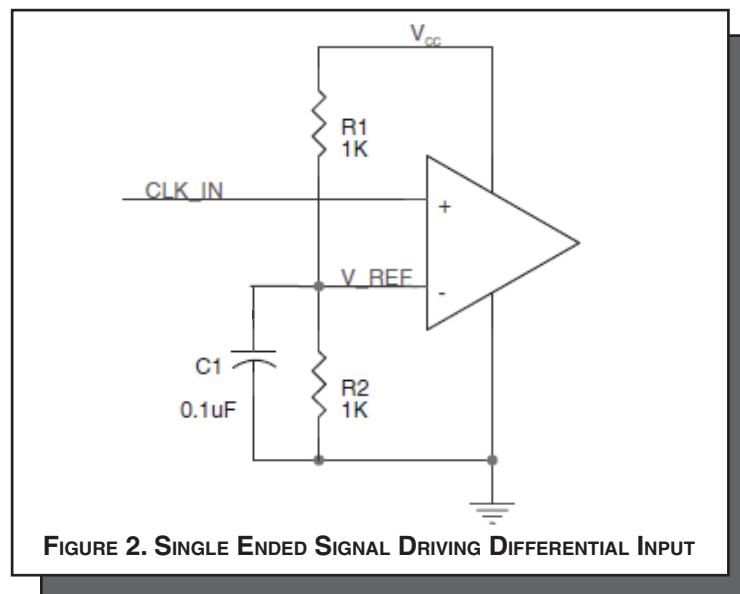
FIGURE 2. SINGLE ENDED SIGNAL DRIVING DIFFERENTIAL INPUT

RECOMMENDATIONS FOR UNUSED INPUT AND OUTPUT PINS

INPUTS:

CLK/nCLK INPUT:
For applications not requiring the use of the differential input, both CLK and nCLK can be left floating. Though not required, but for additional protection, a 1kΩ resistor can be tied from CLK to ground.

PCLK/nPCLK INPUT:
For applications not requiring the use of a differential input, both the PCLK and nPCLK pins can be left floating. Though not required, but for additional protection, a 1kΩ resistor can be tied from PCLK to ground.

LVCMOS CONTROL PINS:
All control pins have internal pull-ups or pull-downs; additional resistance is not required but can be added for additional protection. A 1kΩ resistor can be used.

OUTPUTS:

LVPECL OUTPUT
All unused LVPECL outputs can be left floating. We recommend that there is no trace attached. Both sides of the differential output pair should either be left floating or terminated.

TERMINATION FOR LVPECL OUTPUTS

The clock layout topology shown below is a typical termination for LVPECL outputs. The two different layouts mentioned are recommended only as guidelines.

FOUT and nFOUT are low impedance follower outputs that generate ECL/LVPECL compatible outputs. Therefore, terminating resistors (DC current path to ground) or current sources must be used for functionality. These outputs are designed to drive 50Ω transmission lines. Matched impedance techniques should be used to maximize operating frequency and minimize signal distortion. *Figures 3A and 3B* show two different layouts which are recommended only as guidelines. Other suitable clock layouts may exist and it would be recommended that the board designers simulate to guarantee compatibility across all printed circuit and clock component process variations.
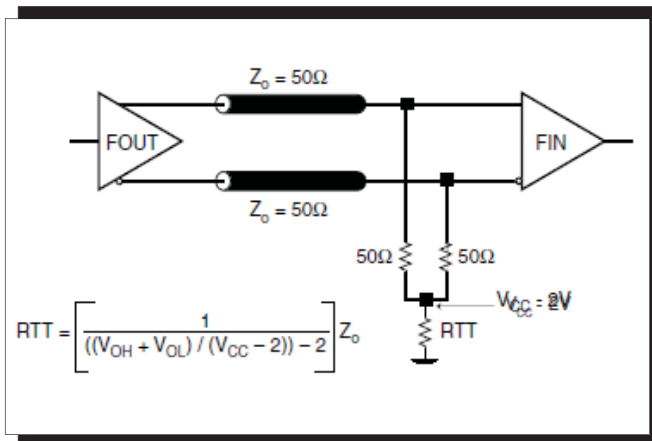

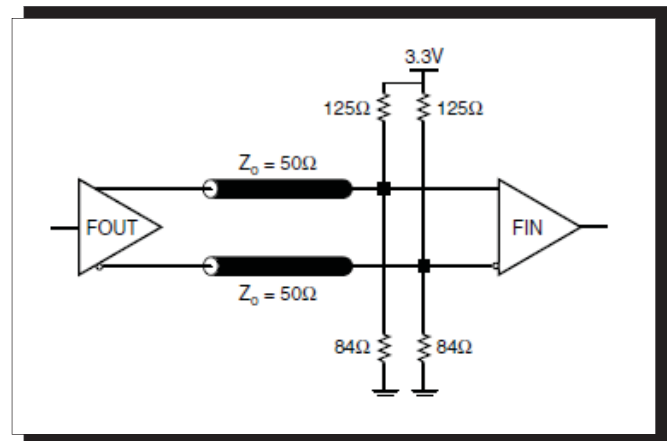**FIGURE 3A. LVPECL OUTPUT TERMINATION**

FIGURE 3B. LVPECL OUTPUT TERMINATION

POWER CONSIDERATIONS

This section provides information on power dissipation and junction temperature for the 8737I-11.
Equations and example calculations are also provided.

1. Power Dissipation.
The total power dissipation for the 8737I-11 is the sum of the core power plus the power dissipated in the load(s).
The following is the power dissipation for $V_{CC} = 3.3V + 5\% = 3.465V$, which gives worst case results.
NOTE: Please refer to Section 3 for details on calculating power dissipated in the load.

- Power (core)$_{MAX}$ = V_{CC_MAX} * I_{CC_MAX} = 3.465V * 55mA = **190.6mW**

- Power (outputs)$_{MAX}$ = **30mW/Loaded Output pair**
  If all outputs are loaded, the total power is 4 * 30mW = **120mW**

  Total Power$_{\_MAX}$ (3.465V, with all outputs switching) = 190.6mW + 120mW = **310.6mW**

2. Junction Temperature.
Junction temperature, Tj, is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for the devices is 125°C.

The equation for Tj is as follows: Tj = θ_{JA} * Pd_total + T_A

Tj = Junction Temperature

θ_{JA} = Junction-to-Ambient Thermal Resistance

Pd_total = Total Device Power Dissipation (example calculation is in section 1 above)
T_A = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance θ_{JA} must be used. Assuming a moderate air flow of 200 linear feet per minute and a multi-layer board, the appropriate value is 66.6°C/W per Table 6 below. Therefore, Tj for an ambient temperature of 85°C with all outputs switching is:

85°C + 0.311W * 66.6°C/W = 105.7°C. This is well below the limit of 125°C

This calculation is only an example. Tj will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (single layer or multi-layer).

TABLE 6. THERMAL RESISTANCE θ_{JA} FOR 20-PIN TSSOP, FORCED CONVECTION

θ_{JA} by Velocity (Linear Feet per Minute)			
	0	**200**	**500**
Single-Layer PCB, JEDEC Standard Test Boards	114.5°C/W	98.0°C/W	88.0°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	73.2°C/W	66.6°C/W	63.5°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

3. Calculations and Equations.

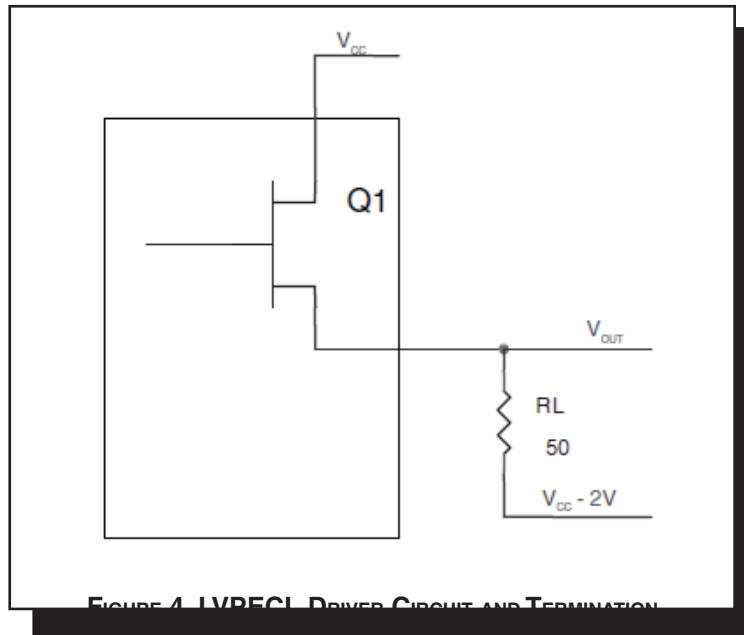LVPECL output driver circuit and termination are shown in *Figure 4.*

FIGURE 4. LVPECL DRIVER CIRCUIT AND TERMINATION

To calculate worst case power dissipation into the load, use the following equations which assume a 50Ω load, and a termination
voltage of V_{CC}- 2V.

- For logic high, $V_{OUT} = V_{OH\_MAX} = \mathbf{V_{CC\_MAX} - 0.9V}$

  $(V_{CC\_MAX} - V_{OH\_MAX}) = \mathbf{0.9V}$

- For logic low, $V_{OUT} = V_{OL\_MAX} = \mathbf{V_{CC\_MAX} - 1.7V}$

  $(V_{CC\_MAX} - V_{OL\_MAX}) = \mathbf{1.7V}$

Pd_H is power dissipation when the output drives high.
Pd_L is the power dissipation when the output drives low.

$Pd\_H = [(V_{OH\_MAX} - (V_{CC\_MAX} - 2V))/R_L] * (V_{CC\_MAX} - V_{OH\_MAX}) = [(2V - (V_{CC\_MAX} - V_{OH\_MAX}))/R_L] * (V_{CC\_MAX} - V_{OH\_MAX}) =$

$[(2V - 0.9V)/50Ω] * 0.9V = \mathbf{19.8mW}$

$Pd\_L = [(V_{OL\_MAX} - (V_{CC\_MAX} - 2V))/R_L] * (V_{CC\_MAX} - V_{OL\_MAX}) = [(2V - (V_{CC\_MAX} - V_{OL\_MAX}))/R_L] * (V_{CC\_MAX} - V_{OL\_MAX}) =$

$[(2V - 1.7V)/50Ω] * 1.7V = \mathbf{10.2mW}$

Total Power Dissipation per output pair = Pd_H + Pd_L = **30mW**

RELIABILITY INFORMATION

TABLE 7. θ_{JA} VS. AIR FLOW TABLE FOR 20 LEAD TSSOP

θ_{JA} by Velocity (Linear Feet per Minute)			
	0	**200**	**500**
Single-Layer PCB, JEDEC Standard Test Boards	114.5°C/W	98.0°C/W	88.0°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	73.2°C/W	66.6°C/W	63.5°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

TRANSISTOR COUNT

The transistor count for 8737I-11 is: 510

PACKAGE OUTLINE - G SUFFIX FOR 20 LEAD TSSOP
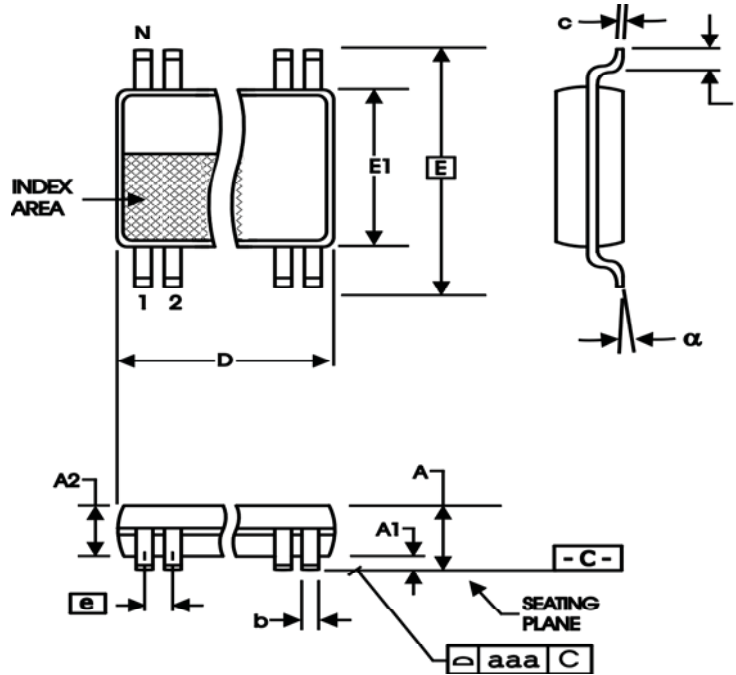
TABLE 8. PACKAGE DIMENSIONS

SYMBOL	Millimeters	
	Minimum	Maximum
N	20	
A	--	1.20
A1	0.05	0.15
A2	0.80	1.05
b	0.19	0.30
c	0.09	0.20
D	6.40	6.60
E	6.40 BASIC	
E1	4.30	4.50
e	0.65 BASIC	
L	0.45	0.75
α	0°	8°
aaa	--	0.10

Reference Document: JEDEC Publication 95, MO-153

TABLE 9. ORDERING INFORMATION

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
8737AGI-11LF	ICS8737AI11L	20 lead "Lead-Free" TSSOP	Tube	-40°C to 85°C
8737AGI-11LFT	ICS8737AI11L	20 lead "Lead-Free" TSSOP	tape & reel	-40°C to 85°C

NOTE: Parts that are ordered with an"LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

REVISION HISTORY SHEET				
Rev	**Table**	**Page**	**Description of Change**	**Date**
A		8	Added Termination for LVPECL Outputs section.	6/3/02
A	1	2	Pin Description Table - revised MR description.	8/19/02
		6	3.3V Output Load Test Circuit Diagram, revised VEE equation from "-1.3V ± 0.135V" to " -1.3V ± 0.165V".	
		7	Revised Output Rise/Fall Time Diagram.	
B		1	Features Section added Lead-Free bullet.	1/12/06
	T2	2	Pin Characteristicst Table - changed C_{IN} from 4pF max. to 4pF typical.	
	T9	8	Added Recommendations for Unused Input and Output Pins.	
		13	Ordering Information Table - added Lead-Free Part/Order Number, Marking and note.	
			Updated format throughout the datasheet.	
C	T4D	5	LVPECL DC Characteristics Table -corrected V_{OH} max. from V_{CC} - 1.0V to V_{CC} - 0.9V; and V_{SWING} max. from 0.9V to 1.0V.	4/13/07
		9 - 10	Power Considerations - corrected power dissipation to reflect V_{OH} max in Table 4D.	
C	T9	13	Updated datasheet's header/footer with IDT from ICS.	8/4/10
			Removed ICS prefix from Part/Order Number column.	
		15	Added Contact Page.	
C	T9	13	Ordering Information - removed leaded devices.	7/16/15
			Updated data sheet format.	

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